TECHNICAL DATA DATASHEET 4193, REV. -

HERMETIC POWER MOSFET - N-CHANNEL

FEATURES:

- 200 Volt, 0.08 Ohm, 27A MOSFET
- Isolated Hermetic Metal Package
- Low R_{DS (on)}

MAXIMUM RATINGS

ALL RATINGS ARE AT $\rm T_{\rm C}$ = 25°C UNLESS OTHERWISE SPECIFIED.

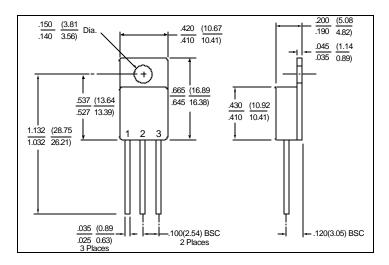
RATING	SYMBOL	MIN.	TYP.	MAX.	UNITS
GATE TO SOURCE VOLTAGE	V_{GS}	-	-	±20	Volts
ON-STATE DRAIN CURRENT	I _{D25}	-	-	27	Amps
PULSED DRAIN CURRENT	I _{DM}	-	-	60	Amps
OPERATING AND STORAGE TEMPERATURE	T _J /T _{STG}	-55	-	+175	°C
TOTAL DEVICE DISSIPATION	P _D	-	-	150	Watts
THERMAL RESISTANCE, JUNCTION TO CASE	$R_{\theta JC}$	-	-	1	°C/W

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMI	BOL MIN.	TYP.	MAX.	UNITS
DRAIN TO SOURCE BREAKDOWN VOLTAGE	BV	oss 200	-	-	Volts
$V_{GS} = 0V, I_D = 2S$	50μΑ				
STATIC DRAIN TO SOURCE ON STATE RESISTAN	ICE R _{DS(}	(ON)			Ω
$V_{GS} = 10V, I_D = 20$	OA	-	0.07	0.08	
GATE THRESHOLD VOLTAGE $V_{DS} = V_{GS}$, $I_D = 25$	0μA V _{GS}	s _(th) 2	-	4	Volts
FORWARD TRANSCONDUCTANCE	9 _f	s 15	-	-	S(1/Ω)
$V_{DS} = 15V, I_{D} = 30$	DA .				
ZERO GATE VOLTAGE DRAIN CURRENT					
$V_{DS} = 0.8 \text{ x Max. rating}, V_{GS} = 0V, T_{J} = 2$	25°C I _{DS}	ss -	-	1	μΑ
$T_{J} = 12$	25°C			50	
GATE TO SOURCE LEAKAGE FORWARD VGS =		ss -	-	100	nA
GATE TO SOURCE LEAKAGE REVERSE V _{GS} =				-100	
TURN ON DELAY TIME $V_{DD} = T_{DD}$		N) -	15	25	
RISE TIME $I_D = 2$	20A t		35	55	nsec
TURN OFF DELAY TIME V _{GS} :	=10V ,				
	t _{d(O}	· ·	40	60	
FALL TIME $R_G =$			30	45) / I
DIODE FORWARD VOLTAGE $I_F = 20A, V_{GS}$		D -	1.0	1.5	Volts
Pulse test, t ≤ 300 μs, duty cycle d ≤					
REVERSE RECOVERY TIME $T_J = 2$	· 1		445	470	
$I_F=50A$, $V_R=$		r -	115	170	nsec
di/dt = 100A/µ					
INPUT CAPACITANCE $V_{GS} =$			2150	-	_
OUTPUT CAPACITANCE $V_{DS} = 2$			215		pF
REVERSE TRANSFER CAPACITANCE f = 1.0N	ИHz C _{rs}	SS	90		

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MECHANICAL DIMENSIONS: in Inches / mm



TO-257

DEVICE TYPE	PIN-1	PIN-2	PIN-3
N-CHANNEL MOSFET	DRAIN	SOURCE	GATE
TO-257 PACKAGE			



TECHNICAL DATA

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